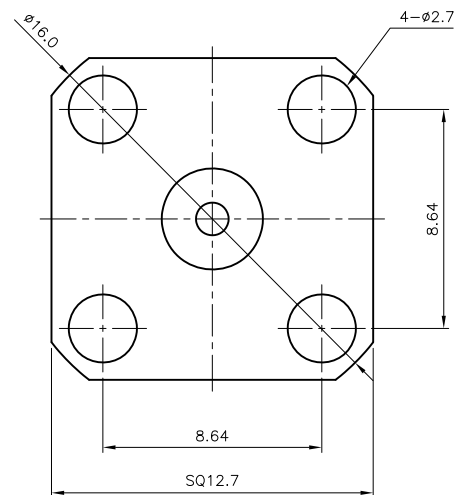
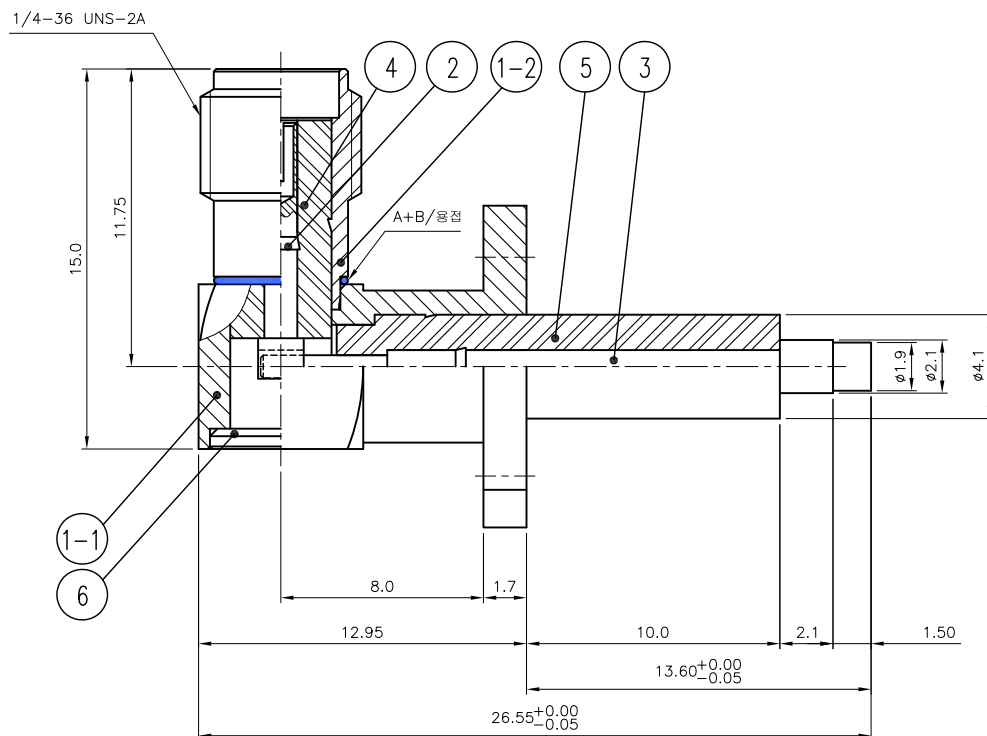


A

B

C

D



REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	I.C.KIM		2019.09.26
1	[출판No.202104-0003] 배디 PUNCH -> HOOK 변경 및 A+B/공점 구조 적용	S.Y.EUN	I.C.KIM	2021.04.09
2	배디 공용화로 인한 코드 변경	S.Y.EUN	I.C.KIM	2021.07.06
3	TP00087-7/2 적용 길이 변경	K.S.KIM	S.L.SON	2022.11.16
4	도금 변경 (Gold => 이온함금)	K.S.KIM	S.L.SON	2022.12.13
5	CN01342-7/6 -> PIN 변경 (DCT04065-5/5 적용)	K.S.KIM	S.L.SON	2023.07.20

6	COVER	1	MBsBD C3604BD-F	Gold Plate	DCO00038-5/1
5	INSULATOR	1	TEFLON		DIN03087-N/2 DIN03087-N/1
4	INSULATOR	1	TEFLON		DIN00112-N/1
3	CONTACT	1	MBsBD C3604BD-F	Gold Plate	DCT04065-5/5
2	CONTACT	1	BeCu C17300	Gold Plate	DCT00151-5/1
1-2	BODY (B)	1	MBsBD C3604BD-F	Gold Plate	DBB00167-5/3 DBD02134-1/3
1-1	BODY (A)	1	MBsBD C3604BD-F	Gold Plate	DBB00167-5/4 DBD00229-1/5
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2023. 07. 20		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY S.L.SON		
MATERIAL	_____	CHECKED BY	S.L.SON	TITLE SMA50 PCB JL-4R
		DRAWN BY	K.S.KIM	
FINISH	_____	SCALE	UNIT	A3
		5/1	mm 	
				DWG NO. CN01342-7/A
				REVISION A SHEET 1 of 1

A

B

C

D